

Customer No.: 31561
Application No.: 10/709,990
Docket No.: 11416-US-PA

AMENDMENTS

To the Claims,

Please amend the claims according to the following listing of claims and substitute it for all prior versions and listing of claims in the application.

1. (currently amended) A solder composition, comprising:

chromium (Cr) in an amount of 5~20 wt.%;

stibium (Sb) in an amount of ~~0.01~~11~50 wt.%;

a component selected from the group consisting of tin (Sn), zinc (Zn), bismuth (Bi), indium (In) and a mixture thereof;

another component selected from the IIIB group in the periodic table or a mixture thereof in an amount of ~~0.01~~9~20 wt.%; and

an impurity.

2. (previously presented) The solder composition according to claim 1, further comprising another component selected from the IVB group in the periodic table or a mixture thereof in an amount of 0.01~10 wt.%.

3. (previously presented) The solder composition according to claim 1, further comprising another component selected from the VB group in the periodic table or a mixture thereof in an amount of 0.01~10 wt.%.

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4. (cancelled)

5. (previously presented) The solder composition according to claim 1, wherein the component selected from the IIIB group in the periodic table or a mixture thereof at least comprises cerium (Ce), samarium (Sm), neodymium (Nd), lutetium (Lu) or a mixture thereof.

6. (original) The solder composition according to claim 1, further comprising another component selected from silver (Ag), copper (Cu) or a mixture thereof having an amount of 0.01~10 wt.%.

7. (cancelled).

8. (original) The solder composition according to claim 1, further comprising another component selected from nickel (Ni), cobalt (Co), manganese (Mn) or a mixture thereof in an amount of 0.01~5 wt.%.

9. (original) The solder composition according to claim 1, further comprising gallium (Ga) in an amount of 0.01~10 wt.%.

Claims 10-14 (cancelled)